

## INFORMATION DISCLOSURE STATEMENT

(Use several sheets if necessary)

Applicant: Coleman et al.

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2854

## U. S. PATENT DOCUMENTS

Examiner's Initials	U.S. Patent No.	Applicant	Issue Date	Class	Sub- class
Ⓢ	4,584,964	Engel	Apr. 29, 1986	118	697
↓	5,129,573	Duffey	Jul. 14, 1992	228	180.1
	5,627,108	Alibocus et al.	May 6, 1997	228	175
	5,740,730	Thompson, Sr.	Apr. 21, 1998	101	127
	5,873,512	Bielick et al.	Feb. 23, 1999	228	216
	5,947,021	Coleman et al.	Sep. 7, 1999	101	120
	6,096,131	Hewett	Aug. 1, 2000	118	504
	6,158,338	MacRaild et al.	Dec. 12, 2000	101	123
	6,171,399	Kaiser et al.	Jan. 9, 2001	118	406
	6,183,839	Bourrieres	Feb. 6, 2001	428	131
↓	6,253,675	Mayer	Jul. 3, 2001	101	127.1

## FOREIGN PATENT DOCUMENTS

Examiner's Initials	Document No.	Country	Date	Translation	
				Yes	No

Examiner's Initials	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)
Ⓢ	✓ Karen Moore-Watts, DEK Printing Machines Ltd., "PumpPrinting to be Highlighted at the Assembly Show," Press Release, September 24, 2001, printed from <a href="http://www.dek.com">http://www.dek.com</a> .
↓	✓ DEK Printing Machines Ltd., Product Catalogue, Screens & Stencils: PumpPrint Stencils, printed from <a href="http://www.dek.com">http://www.dek.com</a> on October 29, 2001.
	✓ Loctite UK Ltd., Technology Pamphlet, "Varidot: Surface Mount Adhesive (SMA) Printing Process," printed from <a href="http://www.loctite-europe.com">http://www.loctite-europe.com</a> on October 30, 2001.
	✓ Rich Lieske and Ken Quigley, "Screen Printing Bottom Side Chip Attach Adhesive," Proceedings of NEPCON West 1997: Alternative Screen Printing Processes, pp. 167-177.
↓	✓ Mark Whitmore, Colin MacKay & Alan Hobby, "Plastic Stencils For Bottomside Chip Attach," Proceedings of NEPCON West 1997: Alternative Screen Printing Processes, pp. 178-191.

EXAMINER Geoffrey EvanishoDATE CONSIDERED 06/05/03

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.